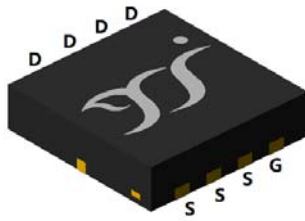
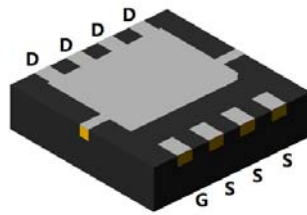


## P-Channel Enhancement Mode Field Effect Transistor

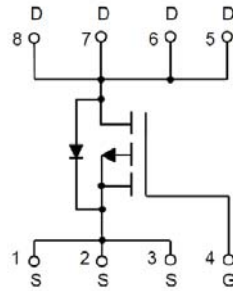


Top View



Bottom View

DFN3333-8L



### Product Summary

- $V_{DS}$  -100V
- $I_D$  -15A
- $R_{DS(ON)}$ ( at  $V_{GS}=10V$ ) < 110m $\Omega$
- $R_{DS(ON)}$ ( at  $V_{GS}=4.5V$ ) < 120m $\Omega$
- 100% EAS Tested

### General Description

- Split gate trench MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low  $R_{DS(ON)}$
- Part no. with suffix "Q" means AEC-Q101 qualified

### Applications

- Power switching application
- Uninterruptible power supply
- DC-DC converter
- 12V, 24V and 48V Automotive systems

### ■ Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		$V_{DS}$	-100	V
Gate-source Voltage		$V_{GS}$	$\pm 20$	V
Drain Current	$T_A=25^\circ\text{C}$	$I_D$	-3.9	A
	$T_A=100^\circ\text{C}$		-2.5	
	$T_C=25^\circ\text{C}$		-15	
	$T_C=100^\circ\text{C}$		-9.5	
Pulsed Drain Current <sup>A</sup>		$I_{DM}$	-35	A
Avalanche energy <sup>B</sup>		EAS	64	mJ
Total Power Dissipation <sup>C</sup>	$T_A=25^\circ\text{C}$	$P_D$	2.5	W
	$T_A=100^\circ\text{C}$		1	
	$T_C=25^\circ\text{C}$		43	
	$T_C=100^\circ\text{C}$		17.2	
Junction and Storage Temperature Range		$T_J, T_{STG}$	-55~+150	$^\circ\text{C}$

### ■ Thermal resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient <sup>D</sup>	Steady-State	$R_{\theta JA}$	40	50	$^\circ\text{C}/\text{W}$
Thermal Resistance Junction-to-Case	Steady-State	$R_{\theta JC}$	2.4	2.9	

### ■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJQ15GP10AQ	F1	Q15GP10A	5000	10000	100000	13" reel



# YJQ15GP10AQ

## ■ Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
<b>Static Parameter</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> =-250μA	-100			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-100V, V <sub>GS</sub> =0V			-1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> =0V			±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =-250μA	-1.0	-1.8	-2.5	V
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = -10V, I <sub>D</sub> =-10A		83	110	mΩ
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> =-5A		95	120	
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =-15A, V <sub>GS</sub> =0V	-		-1.3	V
Maximum Body-Diode Continuous Current	I <sub>S</sub>		-	-	-15	A
<b>Dynamic Parameters</b>						
Gate resistance	R <sub>G</sub>	f=1MHz, Open drain	-	10	-	Ω
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =-25V, V <sub>GS</sub> =0V, f=1MHz	-	1200	-	pF
Output Capacitance	C <sub>oss</sub>		-	200	-	
Reverse Transfer Capacitance	C <sub>rss</sub>		-	25	-	
<b>Switching Parameters</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-50V, I <sub>D</sub> =-5A		20.1	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	3.98	-	
Gate-Drain Charge	Q <sub>gd</sub>		-	4.38	-	
Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> =-5A, di/dt=100A/us	-	140	-	nC
Reverse Recovery Time	t <sub>rr</sub>		-	80	-	ns
Turn-on Delay Time	t <sub>D(on)</sub>	V <sub>GS</sub> =-10V, V <sub>DD</sub> =-50V, I <sub>DS</sub> =-5A R <sub>GEN</sub> =6Ω	-	10	-	ns
Turn-on Rise Time	t <sub>r</sub>		-	30	-	
Turn-off Delay Time	t <sub>D(off)</sub>		-	77	-	
Turn-off fall Time	t <sub>f</sub>		-	81	-	

A. Repetitive rating; pulse width limited by max. junction temperature.

B. T<sub>J</sub>=25°C, V<sub>DD</sub>=-50V, V<sub>G</sub>=-10V, R<sub>G</sub>=25Ω, L=0.5mH, I<sub>AS</sub>=-16A.

C. P<sub>d</sub> is based on max. junction temperature, using junction-case thermal resistance.

D. The value of RθJA is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with TA =25° C. The Power dissipation PDSM is based on RθJA ≤ 10s and the maximum allowed junction temperature of 150° C. The value in any given application depends on the user's specific board design.



# YJQ15GP10AQ

## Typical Electrical and Thermal Characteristics Diagrams

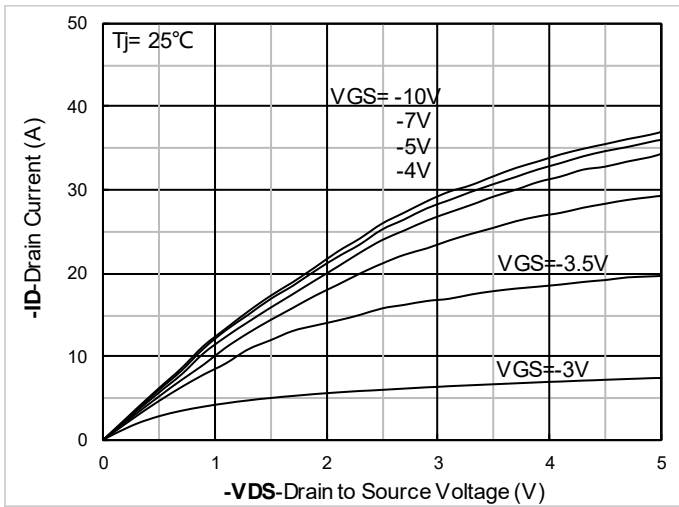


Figure 1. Output Characteristics

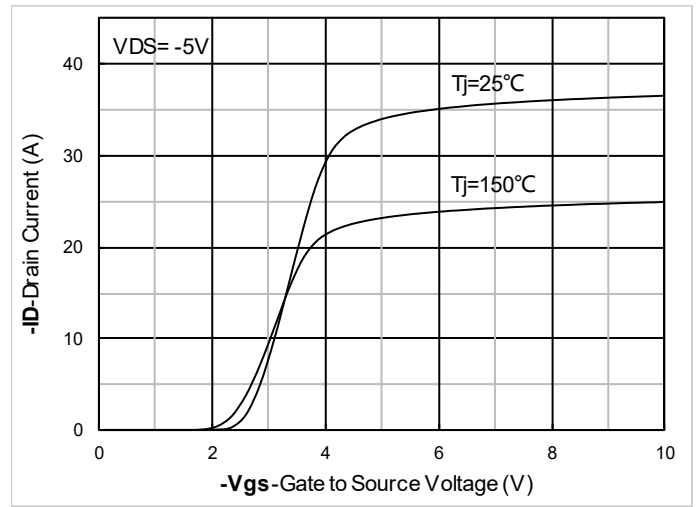


Figure 2. Transfer Characteristics

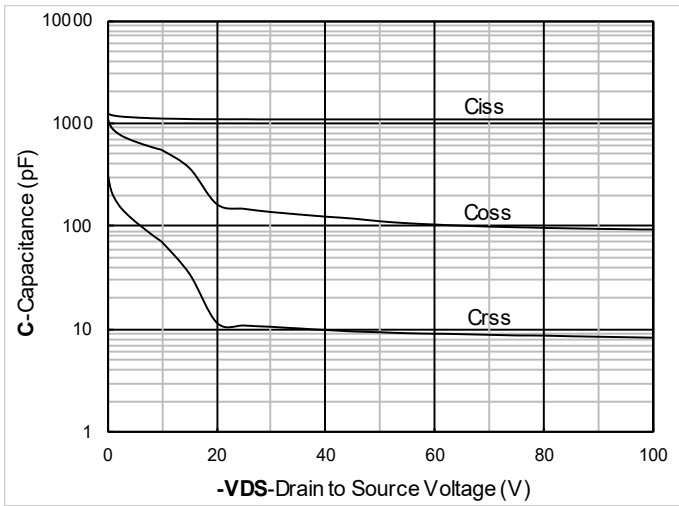


Figure 3. Capacitance Characteristics

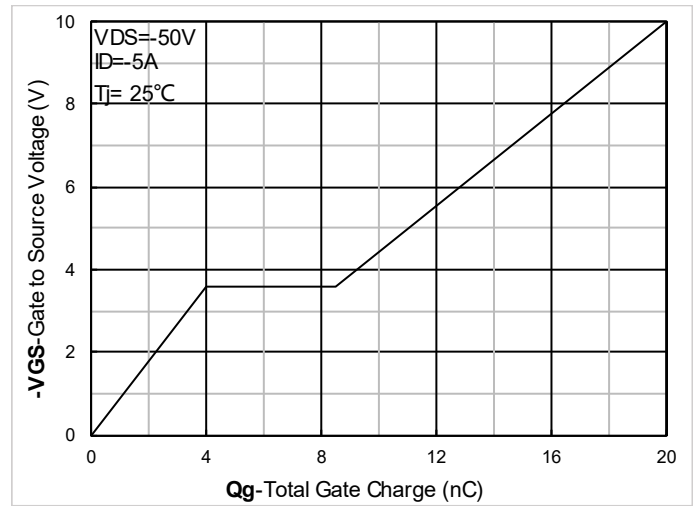


Figure 4. Gate Charge

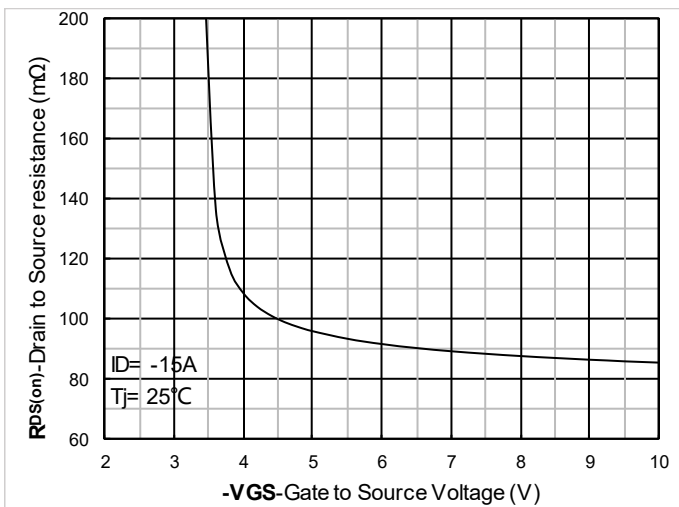


Figure 5. On-Resistance vs Gate to Source Voltage

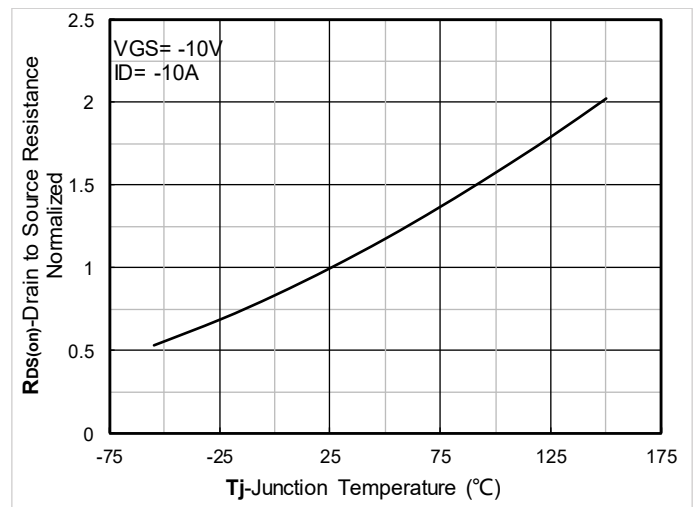


Figure 6. Normalized On-Resistance



# YJQ15GP10AQ

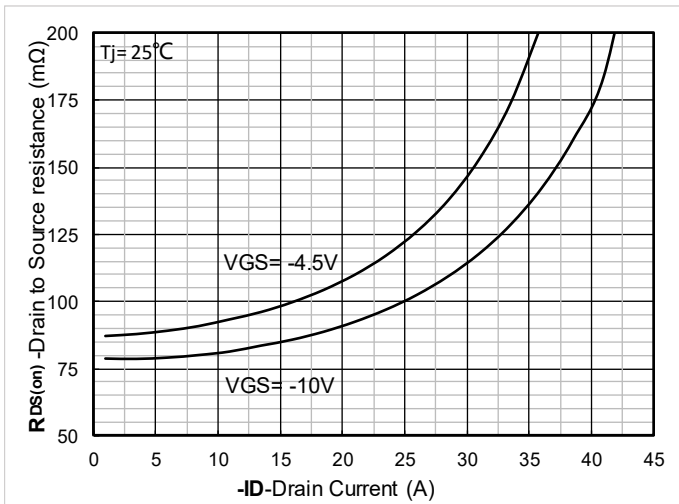


Figure 7.  $R_{DS(on)}$  VS Drain Current

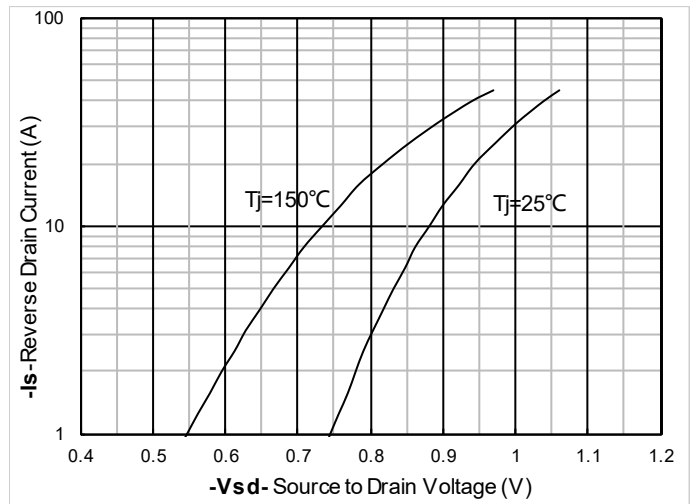


Figure 8. Forward characteristics of reverse diode

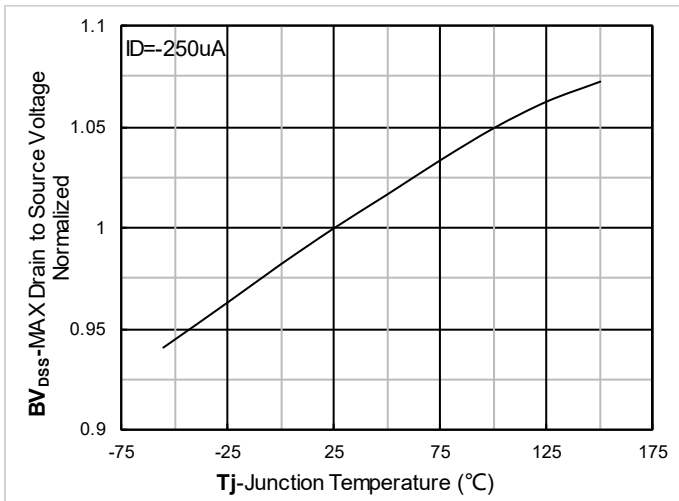


Figure 9. Normalized breakdown voltage

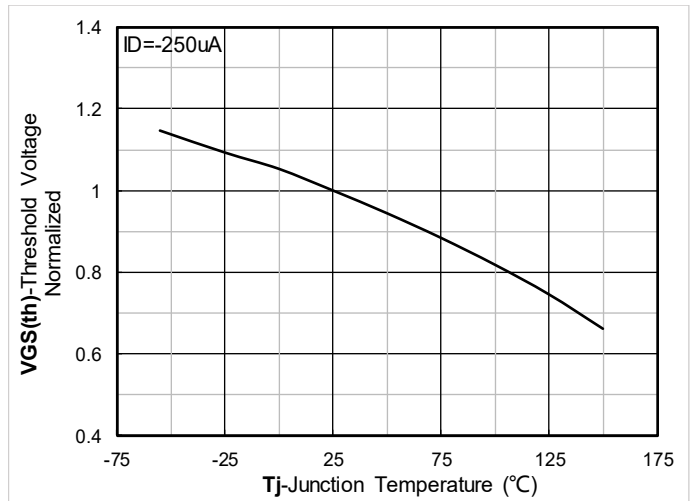


Figure 10. Normalized Threshold voltage

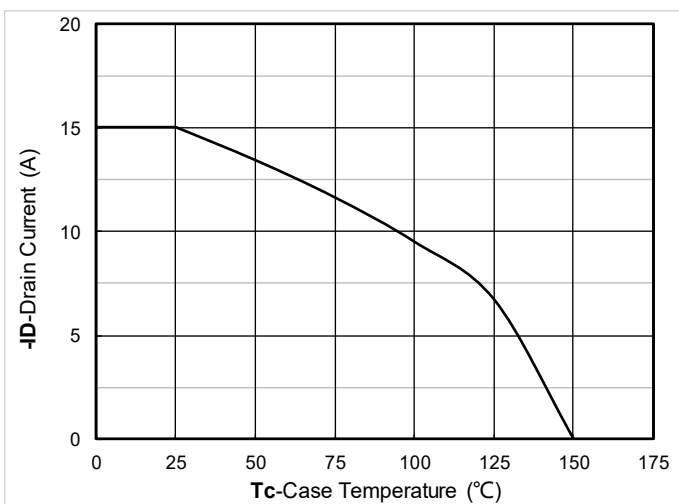


Figure 11. Current dissipation

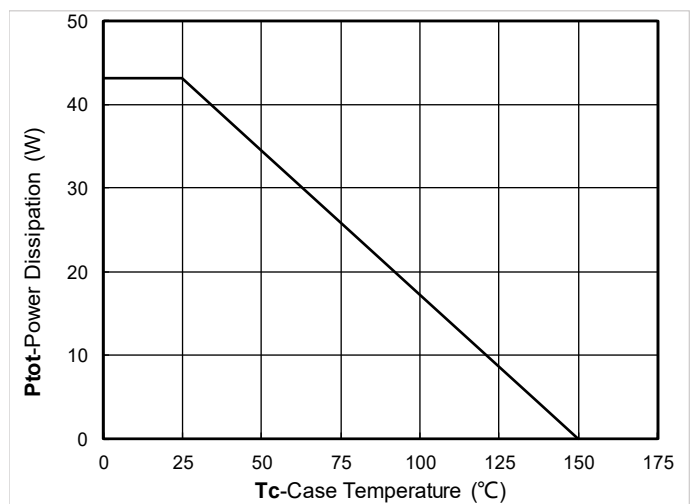


Figure 12. Power dissipation



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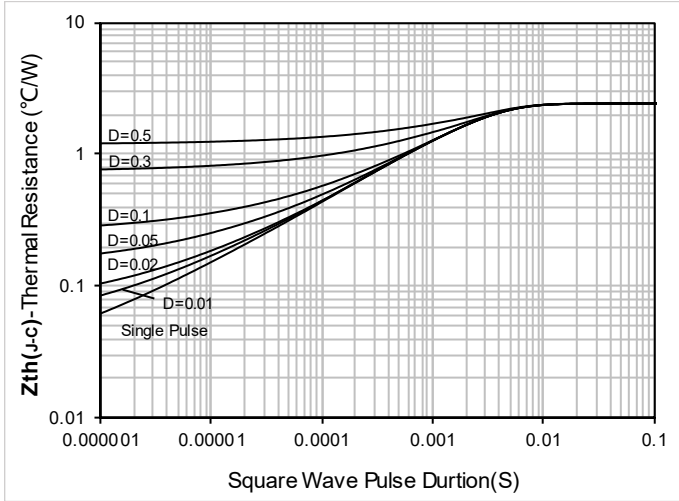


Figure 13. Maximum Transient Thermal Impedance

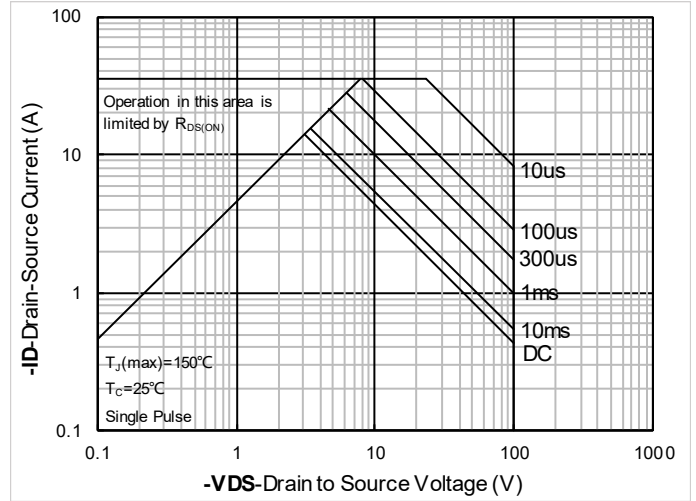
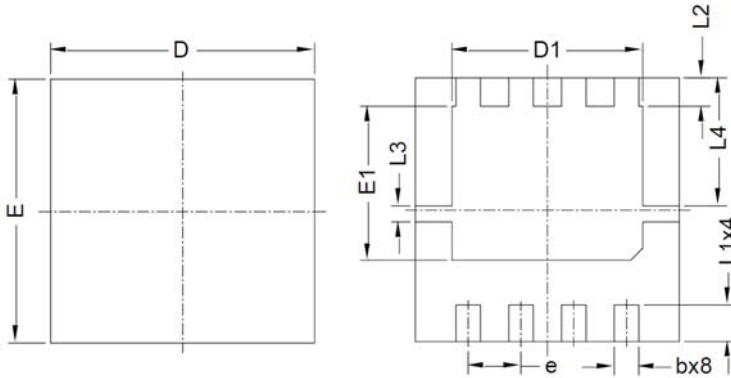


Figure 14. Safe Operation Area



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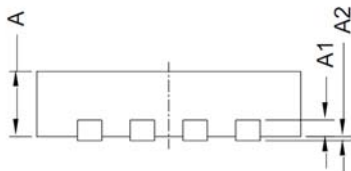
## DFN3333-8L Package information



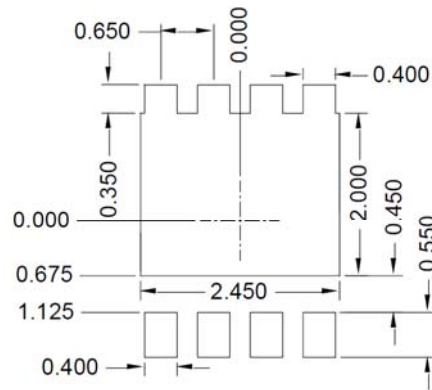
Top View  
正面视图

Bottom View  
背面视图

SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	3.15	3.25	3.35
E	3.15	3.25	3.35
A	0.70	0.80	0.90
A1	0.20 BSC		
A2			0.10
D1	2.20	2.35	2.50
E1	1.80	1.90	2.00
L1	0.35	0.45	0.55
L2	0.35 BSC		
L3	0.20 BSC		
L4	1.57 BSC		
b	0.20	0.30	0.40
e	0.65 BSC		



Side View  
侧面视图



Suggested Solder Pad Layout  
Top View

Note:

1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.10$ mm.
3. The pad layout is for reference purposes only.



## YJQ15GP10AQ

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